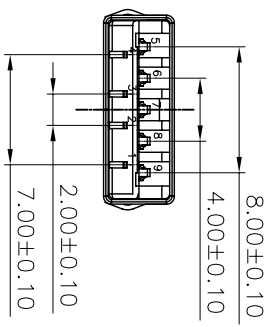
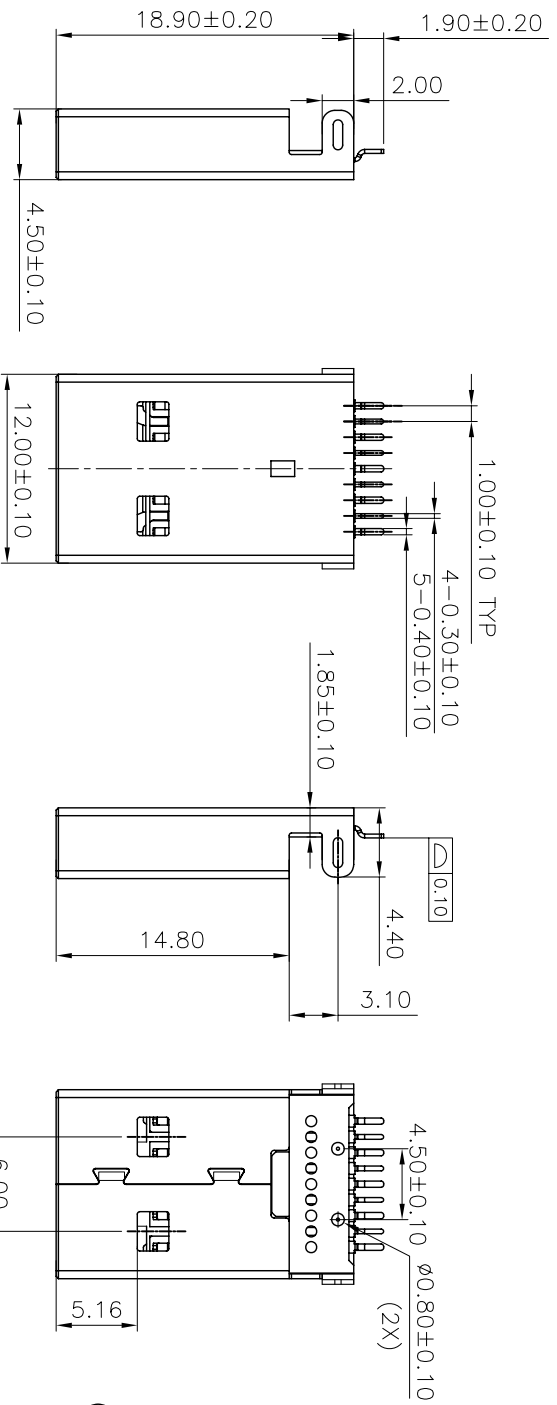
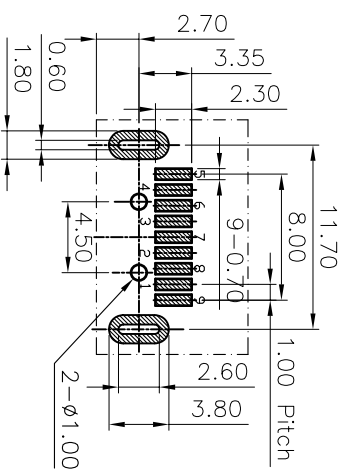
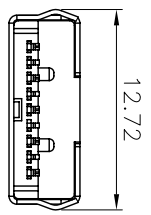


REV.	ECN NO.	DESCRIPTION	DRAW	CHECK	APPD.	DATE
A0	ECN120306011	新发行	xu dong bin	—	—	12-03-06
A1	ECN130801001	变更料号	WEI	—	—	13-08-01



SPECIFICATIONS:
 Contact current Rating:
 1.8 Amperes for pin1&pin4,
 0.25 Amperes other contacts
 Dielectric Withstanding Voltage:AC 100V(RMS)
 Insulation resistance:100Megaohms Minimum.
 Contact Resistance:
 30mΩ Max for pin1&pin4
 50mΩMax for other contacts
 Mechanical Characteristics:
 Mating Force:35 Newtons,Maximum
 Unmating Force:10 Newtons,Minimum.
MATERIAL:
 Housing: LCP+30%GF 94V-0 COLOR:BLUE
 Contact: copper alloy(T=0.25mm)
PLATING:
 Contact: Au Plated on contact area
 Tin Plated on solder area
 Nickel Underplating over all
 Shell: Nickel Plated
 operating Temperature:-55to+85°

Pin NUMBER	SIGNAL NAME	UNLESS OTHERWISE SPECIFIED TOLERANCES	APPROVAL	日期	品名规格	USB AM 3.0 SMT L=1.9 K脚
1	VBUS	METRIC 0.30	制图 WEIMINGJUN	2012.03.06		
2	D-	METRIC 0.25	审核 xudongbin	2012.03.06		
3	D+	METRIC 0.25	核准 xudongbin	2012.03.06		
4	GND	ANGLES +/- 2.00°	文件位置			
5	Stda_SSRX-					
6	Stda_SSRX+					
7	GND_DRAIN					
8	Stda_SSTX-					
9	Stda_SSTX+					
Shell/Shield						

料号备注:
CU3M002MXXTXXR

"12"半高零插G/F"
 "15"半高零插15U"
 "16"半高零插30U"
 "00"-LCP

